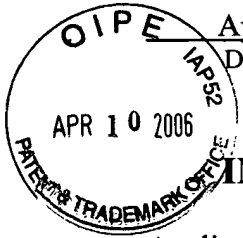


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April 6, 2006

Date Mailed

Yuko Tanaka

Name

*U. Tanaka*

Signature

April 6, 2006

Date

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Koning *et al.*

Serial No.: 10/815,291

Filed: March 30, 2004

For: MICROELECTRONIC PACKAGES  
INCLUDING NANOCOMPOSITE  
DIELECTRIC BUILD-UP MATERIALS  
AND NANOCOMPOSITE SOLDER  
RESIST

Examiner: Luan C. Thai

Art Unit: 2891

Docket No.: 42P18770

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT A (37 C.F.R. § 1.111)**

Sir:

This amendment is submitted in response to the Office Action mailed December 8, 2005, for the above-noted patent application.

Applicants respectfully request that the Examiner do the following with this amendment:

1. Please enter the amendments to the specification, if any, in section I.
2. Please enter the amendments to the claims, if any, in section II.
3. Please consider the specification amendments in section I and the claims in section II in view of the remarks in section III.